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(12) **United States Design Patent** (10) **Patent No.:** **US D962,184 S**  
**Sugiura et al.** (45) **Date of Patent:** **\*\* Aug. 30, 2022**

(54) **RETAINER PLATE OF TOP HEATER FOR WAFER PROCESSING FURNACE**

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(51) **LOC (13) Cl.** ..... **13-03**

(52) **U.S. Cl.**  
USPC ..... **D13/182; D15/144.1**

(58) **Field of Classification Search**

USPC ..... D13/182, 184, 199, 123; D15/144, D15/144.1, 144.2, 140, 199; 156/345.12, 156/345.13, 345.14, 471, 472, 345.37, 156/345.62, 912; 451/173, 177, 28, 282, 451/286, 287, 288, 290, 296, 307, 398, 451/51; 118/728  
 CPC ..... H01L 21/67098; H01L 21/67103; H01L 21/67109; H01L 21/67115; H01L 21/67; H01L 21/673; H01L 21/6735; H01L 21/67369; H01L 21/67011; H01L 21/67757; B24B 5/00; B24B 37/27; B24B 37/30; B24B 37/32; B24B 29/00; B24B 7/22; B24B 7/228; C23C 16/4587; C23C 16/45546; C23C 16/4584; C23C 16/46; C23C 16/458

See application file for complete search history.

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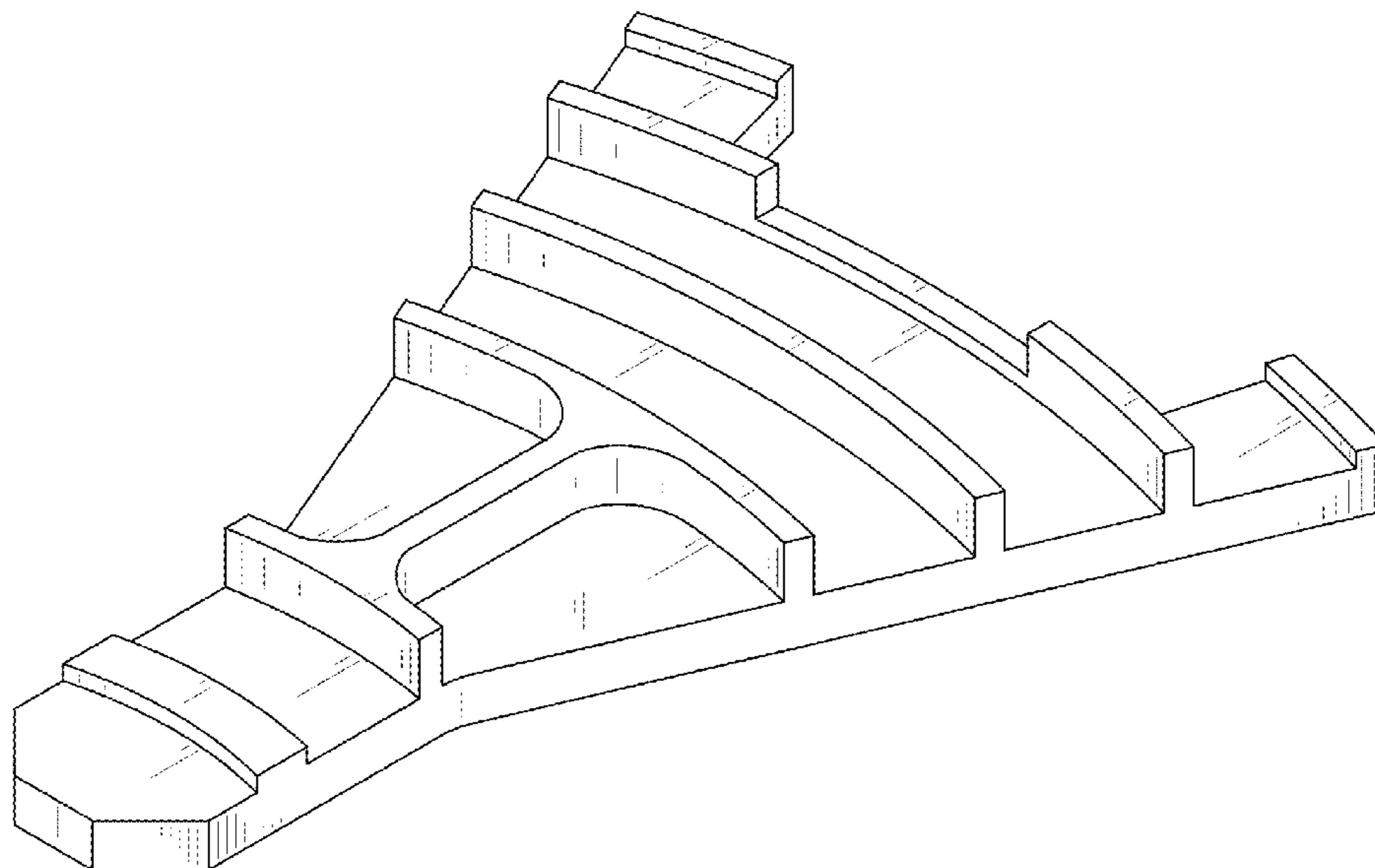
(57) **CLAIM**

The ornamental design for a retainer plate of top heater for wafer processing furnace, as shown and described.

**DESCRIPTION**

FIG. 1 is a front, top and right side perspective view of a retainer plate of top heater for wafer processing furnace showing our new design;  
 FIG. 2 is a front elevational view thereof;  
 FIG. 3 is a left side elevational view thereof;  
 FIG. 4 is a right side elevational view thereof;  
 FIG. 5 is a top plan view thereof; and  
 FIG. 6 is a bottom plan view thereof.  
 FIG. 7 is a rear elevational view thereof; and,  
 FIG. 8 is a cross-sectional view taken along line 8-8 in FIG. 2.

**1 Claim, 6 Drawing Sheets**



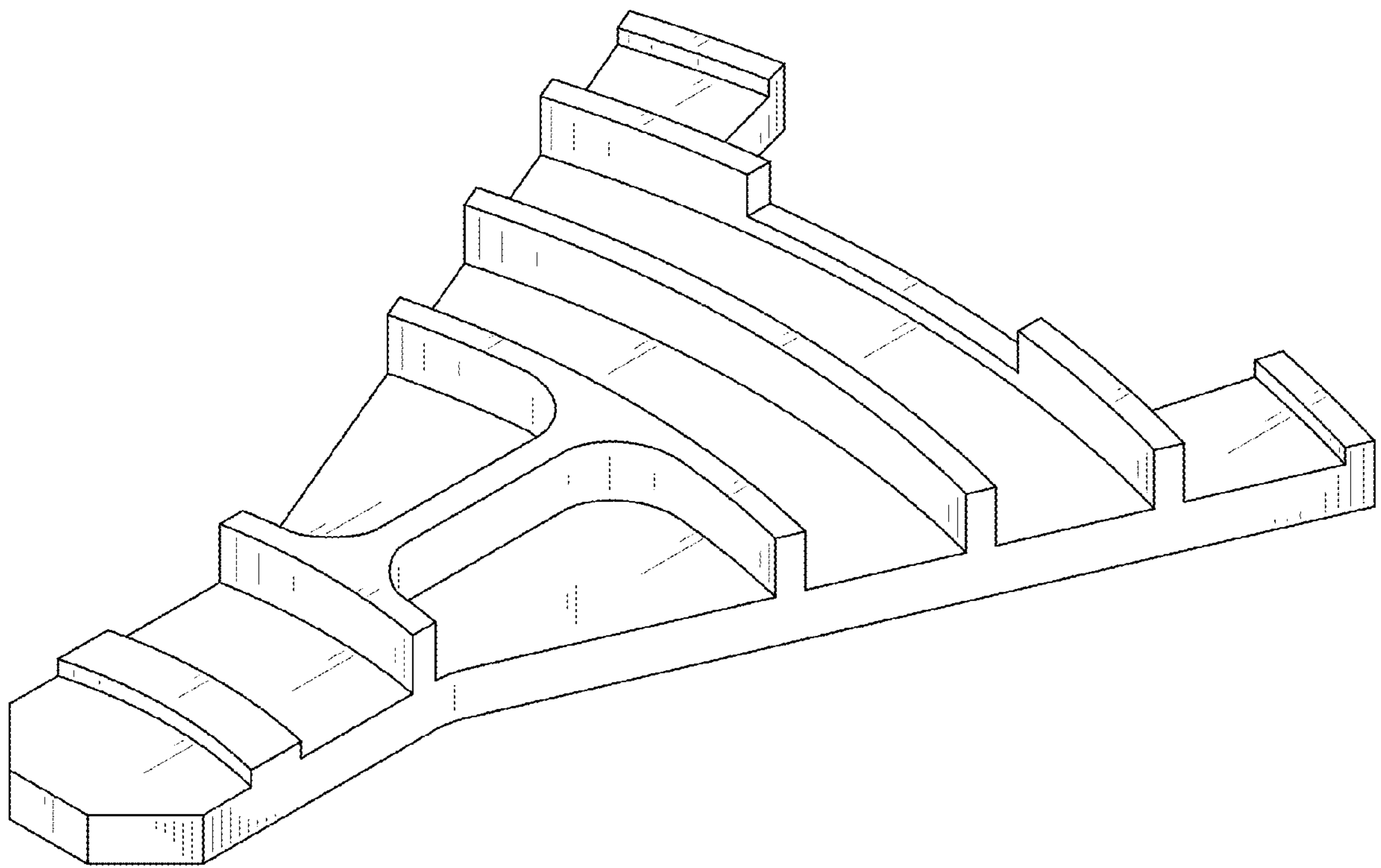
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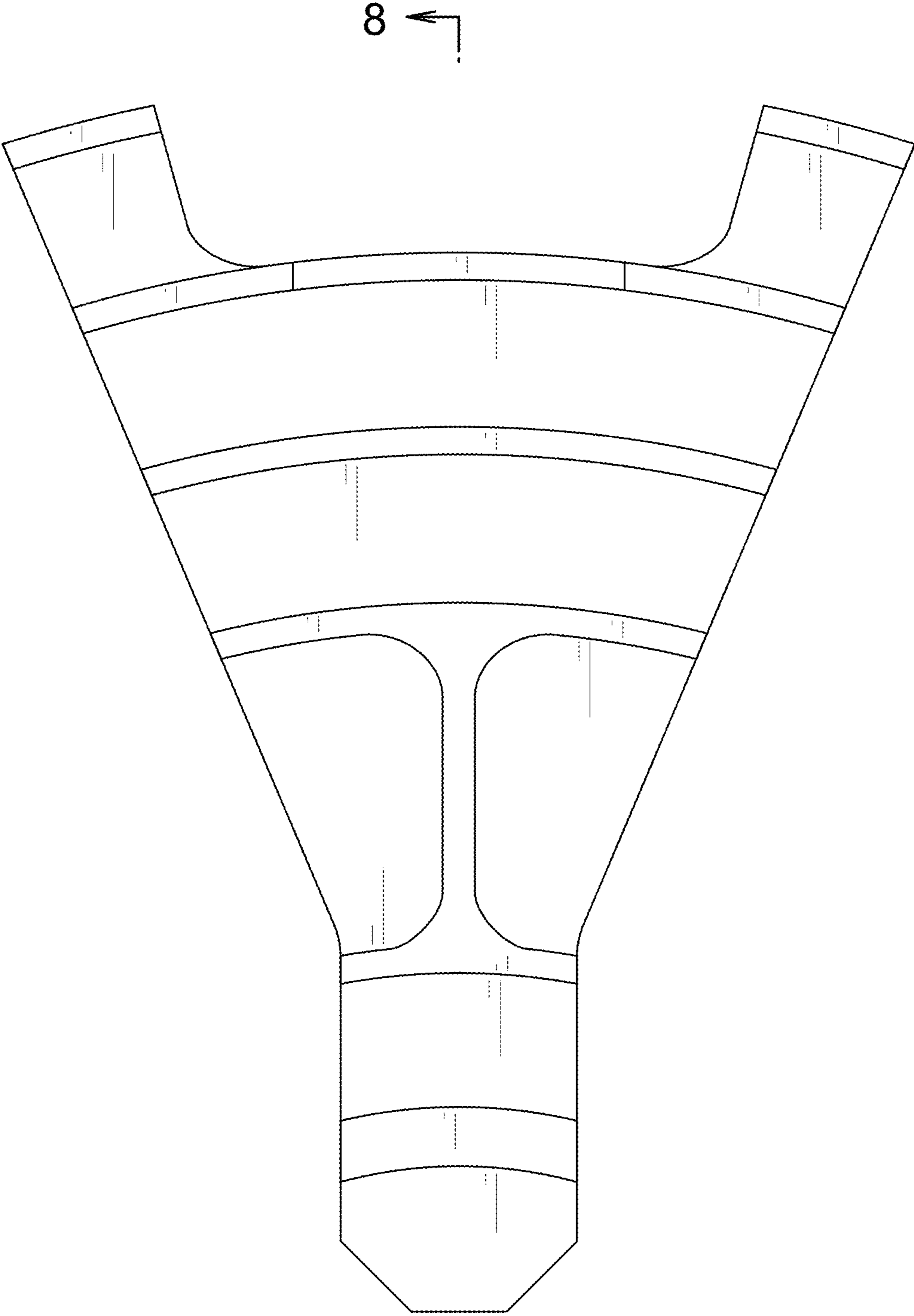
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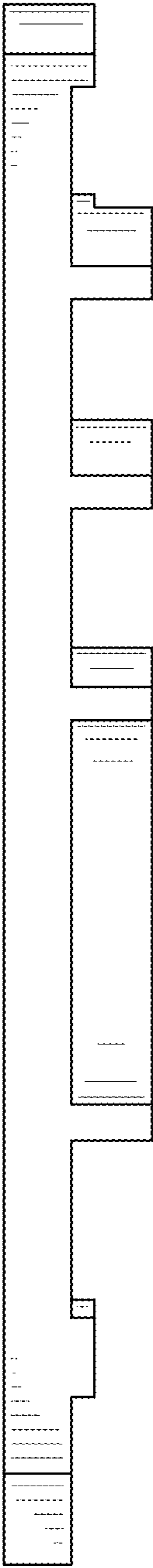
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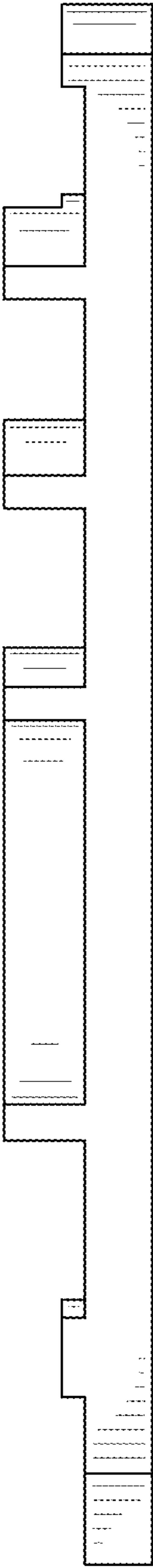
*FIG. 1*



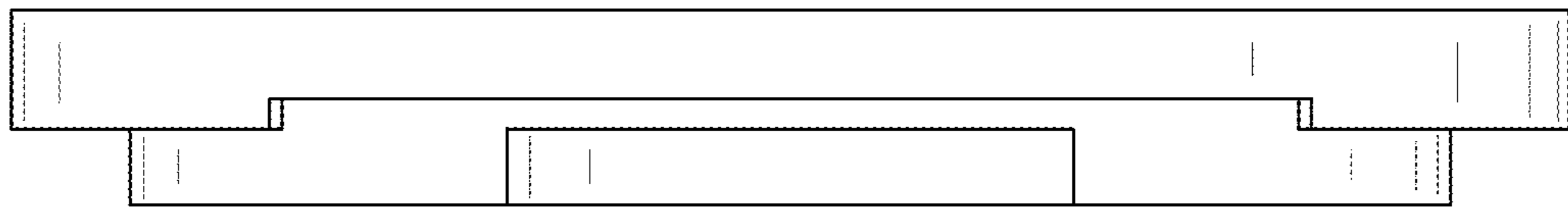
**FIG. 2**



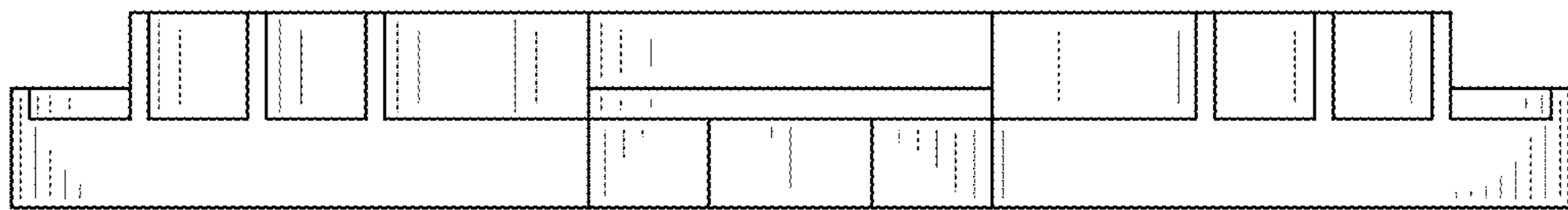
**FIG. 3**



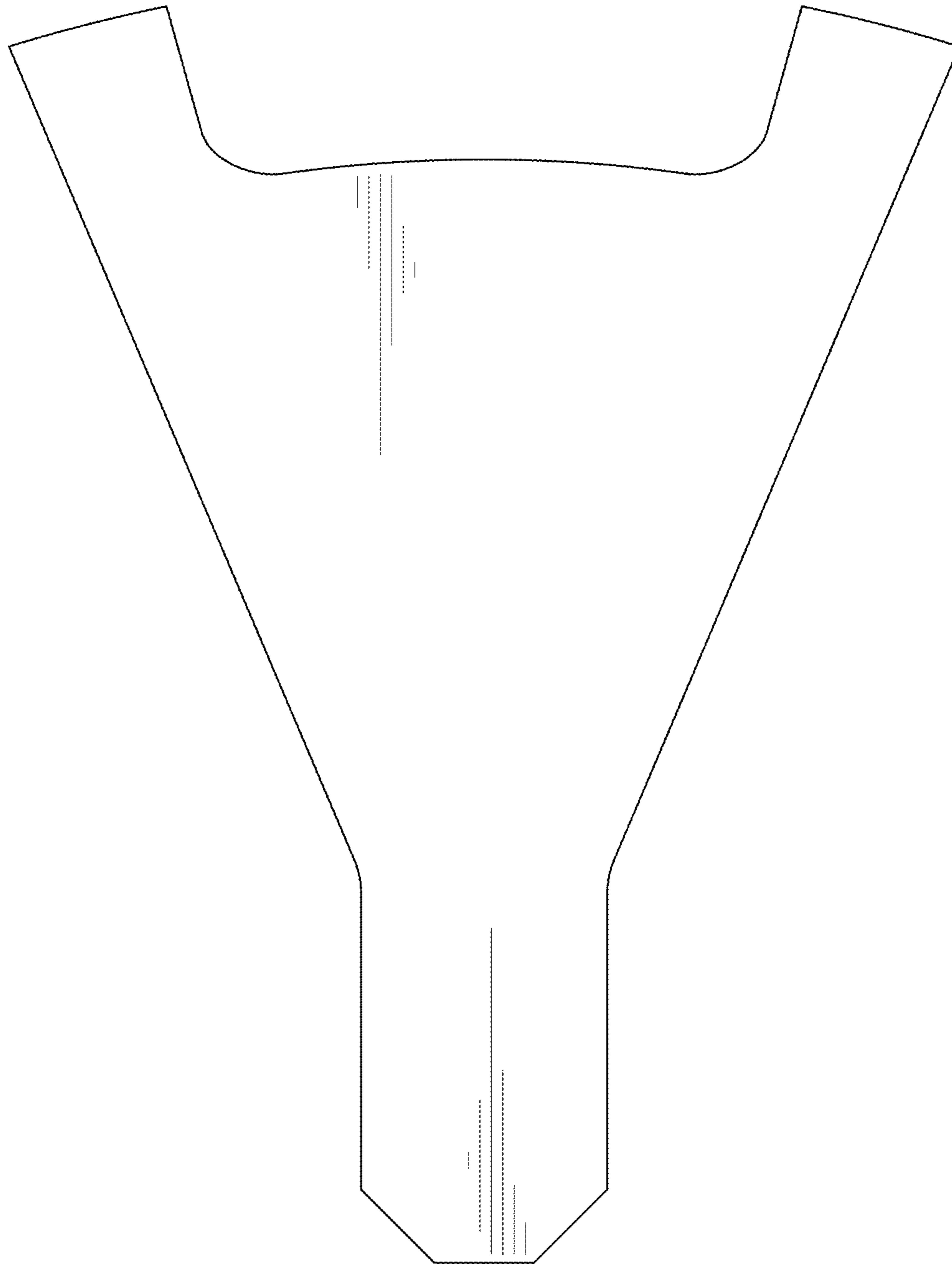
**FIG. 4**



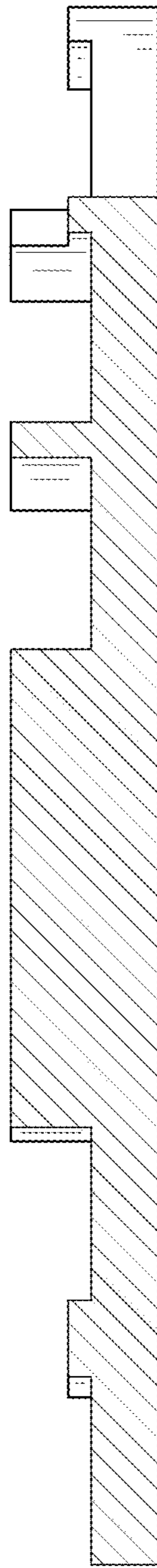
*FIG. 5*



*FIG. 6*



**FIG. 7**



**FIG. 8**